# **Prayag Anil Gore**

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# **EDUCATION**

# **Doctor of Philosophy in Mechanical Engineering (Ph.D.)**

Intended Dec 2025

Micro and Nano Manufacturing Laboratory, University of Cincinnati, Cincinnati, OH, USA

**GPA: 3.813** 

Thesis: Machine Learning for Performance Enhancement in Electrochemical Machining via Predictive Diagnostics

# Master of Science in Mechanical Engineering (MS)

Dec 2022

Center for Intelligent Maintenance Systems, University of Cincinnati, Cincinnati, OH, USA (IMS Center)

GPA: 3.803

Thesis: PHM Methodology for Location-based Health Evaluation and Fault Classification of Linear Motion Systems\

## **TECHNICAL SKILLS**

**Data Analysis & Visualization:** Python (Pandas, TensorFlow, Scikit-learn, NumPy), R, MATLAB, SQL, Git, Tableau **Machine Learning**: Deep Learning, SVM, SOM, Random Forest, Signal Processing, Time Series, Image Processing

#### **WORK EXPERIENCE**

# **P&G Digital Accelerator**

Jan 2021 - Present

Machine Learning Engineer and Systems Engineer

- **Designed and implemented Image Data Augmentation framework** for training deep learning models for quality control of feminine hygiene <u>products increasing dataset from 10K → 100K images</u> without losing classification accuracy.
- Developed Systems Engineering models of complex manufacturing systems via interviews of subject matter experts.
- Accurately mapped the consumer needs to manufacturing processes and raw materials by analyzing their impacts on final product quality, using model-based systems engineering (MBSE).

# Micro and Nano Manufacturing Laboratory

Aug 2023 - Present

Graduate Research Assistant

- **Developed Image processing technique** using "adaptive background modeling" to detect and map spark discharges. Spark detection capability was <u>enhanced by 150% when compared with supervised deep learning</u> methodology
- Extracted gas film dynamics via edge detection on high-speed camera data; applied Gaussian Process Regression (GPR) to model relationships between input parameters and output characteristics.
- Developed data acquisition system to monitor electrolyte behavior and statistically quantify performance degradation.

## **Intelligent Maintenance Systems**

Aug 2020 - Dec 2022

**Graduate Research Assistant** 

- Developed a transfer learning methodology for detection of health degradation and fault classification tasks using data from non-connected ball screw systems, with deep learning techniques.
- Designed a fault classification approach for PCB manufacturing with highly imbalanced datasets, leveraging feature
  engineering and gradient boosting algorithms (PHM Europe Data Challenge 2022 won 2<sup>nd</sup> place)
- Authored and published research papers on machine learning applications for ball screw health evaluation, fault classification, and PCB manufacturing.

## SAE India - Team Pegasus Racing

Aug 2016 - December 2018

Design and Manufacturing Team for Steering

- Developed an Ackerman steering system for formula-3 race car for SAE India's Supra racing competition.
- Designed steering quick release mechanism for maneuverability and safety testing

# PUBLICATIONS [Google Scholar Profile]

- 1. **Gore, P.**, Chen, Y.-J., & Sundaram, M. (2024). Unsupervised detection and mapping of sparks in the Electrochemical Discharge Machining (ECDM) process. Manufacturing Letters, 41, 435–441. [Link]
- 2. Kundu, P., Miller, M., **Gore, P.,** Jia, X., & Lee, J. (2023). Detection of inception of preload loss and remaining life prediction for ball screw considering change in dynamics due to worktable position. *Mechanical Systems and Signal Processing*, 189, 110075. [Link]
- 3. **Gore**, **P.**, John Taco, Minami, T., Kundu, P., & Lee, J. (2022). A Novel Methodology for Health Assessment in Printed Circuit Boards. *PHM Society European Conference*, *7*(1), 556–562. [Link]
- 4. Lee, J., **Gore, P.,** Jia, X., Siahpour, S., Kundu, P., & Sun, K. (2022). Stream-of-quality methodology for industrial internet-based manufacturing system. Manufacturing Letters, 34, 58–61. [Link]